



CST4606A N-Ch and P-Ch Fast Switching MOSFETs

CST4606A Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

CST4606A Applications

- Power management in half bridge and inverters
- DC-DC Converter
- Load Switch

CST4606A General Description

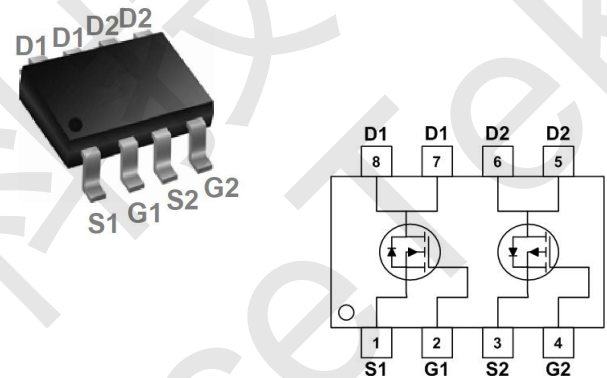
The CST4606A is the highest performance trenchN-ch and P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The CST4606A meet the RoHS and Green Product requirement , 100% EAS guaranteedwith full function reliability approved.

CST4606A Product Summary

| BVDSS | RDSON | ID |
|-------|-------|-----|
| 30V | 18mΩ | 7A |
| -30V | 36mΩ | -6A |

CST4606A SOP8 Pin Configurations



CST4606A Absolute Maximum Ratings

| Symbol | Parameter | Rating | | Units |
|-----------------------|--|------------|------------|------------|
| | | N-Channel | P-Channel | |
| V_{DS} | Drain-Source Voltage | 30 | -30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | ± 20 | V |
| $I_D@T_C=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 7.0 | -6 | A |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 6 | -4 | A |
| I_{DM} | Pulsed Drain Current ² | 20 | -12 | A |
| EAS | Single Pulse Avalanche Energy ³ | 72 | 59 | mJ |
| I_{AS} | Avalanche Current | 21 | -19 | A |
| $P_D@T_C=25^\circ C$ | Total Power Dissipation ⁴ | 2.5 | 2.08 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | -55 to 150 | $^\circ C$ |

CST4606A Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ | --- | 85 | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | --- | 50 | $^\circ C/W$ |



CST4606A N-Ch and P-Ch Fast Switching MOSFETs

CST4606A Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|--|--|------|-------|-----------|----------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$ | 30 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | --- | 0.034 | --- | V/ $^\circ\text{C}$ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance ² | $V_{GS}=10V, I_D=6A$ | --- | 18 | 25 | m Ω |
| | | $V_{GS}=4.5V, I_D=5A$ | --- | 25 | 31 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}, I_D=250\mu A$ | 1.0 | 1.5 | 2.5 | V |
| $\Delta V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | | --- | -5.8 | --- | mV/ $^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=30V, V_{GS}=0V, T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{DS}=30V, V_{GS}=0V, T_J=55^\circ\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | --- | --- | ± 100 | nA |
| gfs | Forward Transconductance | $V_{DS}=15V, I_D=5A$ | --- | 10 | --- | S |
| R_g | Gate Resistance | $V_{DS}=24V, V_{GS}=0V, f=1\text{MHz}$ | --- | 2.5 | --- | Ω |
| Q_g | Total Gate Charge (4.5V) | $V_{DS}=20V, V_{GS}=4.5V, I_D=6A$ | --- | 7.2 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 1.4 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 2.2 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=12V, V_{GS}=10V, R_G=3.3\Omega, I_D=5A$ | --- | 3.9 | --- | ns |
| T_r | Rise Time | | --- | 9.2 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 14.5 | --- | |
| T_f | Fall Time | | --- | 6.0 | --- | |
| C_{iss} | Input Capacitance | $V_{DS}=25V, V_{GS}=0V, f=1\text{MHz}$ | --- | 370 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 54 | --- | |
| C_{riss} | Reverse Transfer Capacitance | | --- | 40 | --- | |

CST4606A Guaranteed Avalanche Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|--|--|------|------|------|------|
| EAS | Single Pulse Avalanche Energy ⁵ | $V_{DD}=25V, L=0.1\text{mH}, I_{AS}=10A$ | 16 | --- | --- | mJ |

CST4606A Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|--|---|------|------|------|------|
| I_S | Continuous Source Current ^{1,6} | $V_G=V_D=0V$, Force Current | --- | --- | 7 | A |
| I_{SM} | Pulsed Source Current ^{2,6} | | --- | --- | 20 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{GS}=0V, I_S=5A, T_J=25^\circ\text{C}$ | --- | --- | 1.2 | V |

Note :

- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, $t < 10\text{sec}$.
- The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- The EAS data shows Max. rating. The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=10A$
- The power dissipation is limited by 150°C junction temperature
- The Min. value is 100% EAS tested guarantee.
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



CST4606A N-Ch and P-Ch Fast Switching MOSFETs

CST4606A Electrical Characteristics (T_J=25°C unless otherwise noted)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|--|----------------------|--|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = -250μA | -30 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = -30V, V _{GS} = 0V | - | - | -1 | μA |
| Gate-Source Leakage | I _{GSS} | V _{DS} = 0V, V _{GS} = ±20V | - | - | ±100 | nA |
| Gate-Source Threshold voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = -250μA | -1 | -1.5 | -2.5 | V |
| Drain-Source on-State Resistance ³ | R _{DS(on)} | V _{GS} = -10V, I _D = -4.1A | - | 36 | 60 | mΩ |
| | | V _{GS} = -4.5V, I _D = -3A | - | 50 | 85 | |
| Dynamic Characteristics⁴ | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0V, V _{DS} = -15V, f = 1.0MHz | - | 530 | - | pF |
| Output Capacitance | C _{oss} | | - | 70 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 56 | - | |
| Switching Characteristics⁴ | | | | | | |
| Total Gate Charge | Q _g | V _{GS} = -10V, V _{DS} = -15V, I _D = -4.1A | - | 6.8 | - | nC |
| Gate-Source Charge | Q _{gs} | | - | 1.0 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 1.4 | - | |
| Turn-on Delay Time | t _{d(on)} | V _{GS} = -10V, V _{DS} = -15V , R _L = 15Ω,R _{GEN} = 2.5Ω | - | 14 | - | ns |
| Rise Time | t _r | | - | 61 | - | |
| Turn-off Delay time | t _{d(off)} | | - | 19 | - | |
| Fall Time | t _f | | - | 10 | - | |
| Source-Drain Body Diode Characteristics | | | | | | |
| Diode Forward Voltage ³ | V _{SD} | I _S = -4.1A, V _{GS} = 0V | - | - | -1.2 | V |
| Continuous Source Current | I _S | | - | - | -5.0 | A |

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.
2. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
3. Pulse Test: Pulse width≤300μs, duty cycle≤2%.
4. This value is guaranteed by design hence it is not included in the production test.



CST4606A N-Channel Typical Characteristics

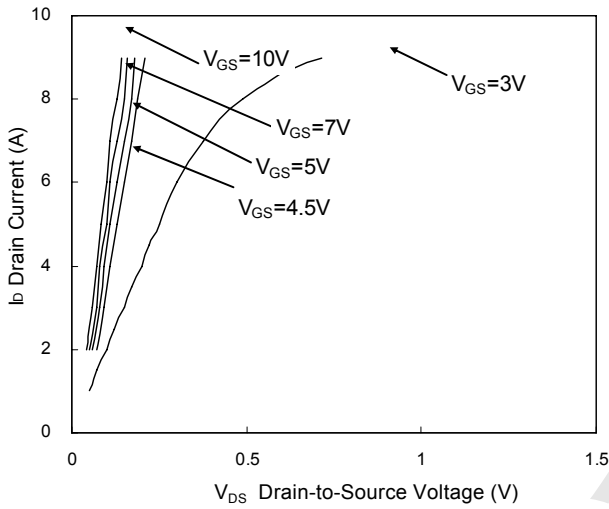


Fig.1 Typical Output Characteristics

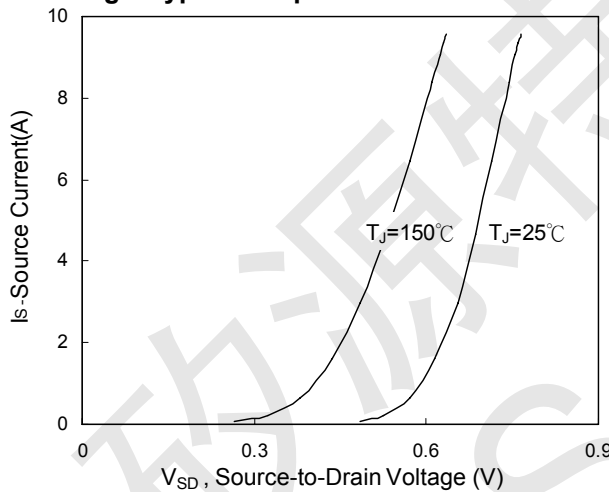
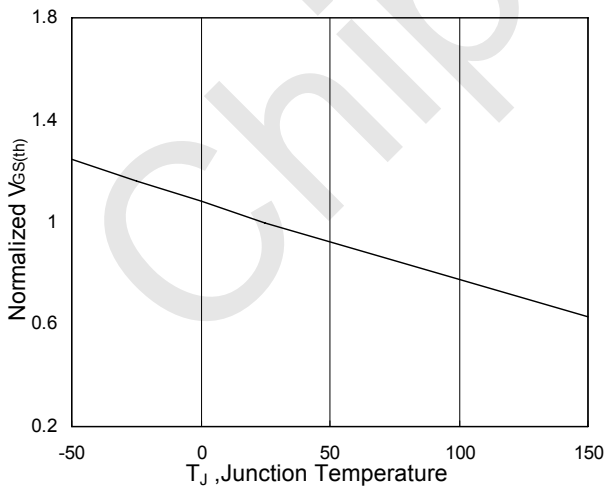


Fig.3 Forward Characteristics of Reverse



(°C) Fig.5 V_{GS(th)} vs. T_J

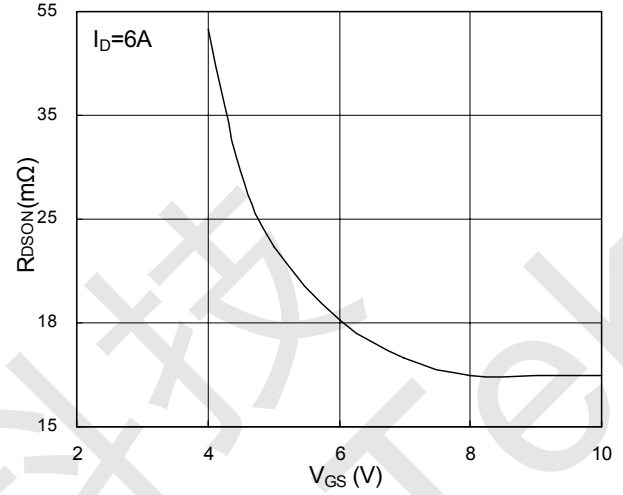


Fig.2 On-Resistance vs. G-S Voltage

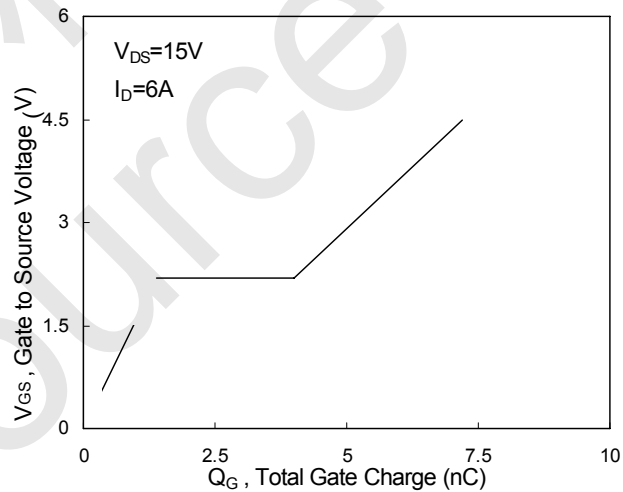


Fig.4 Gate-charge Characteristics

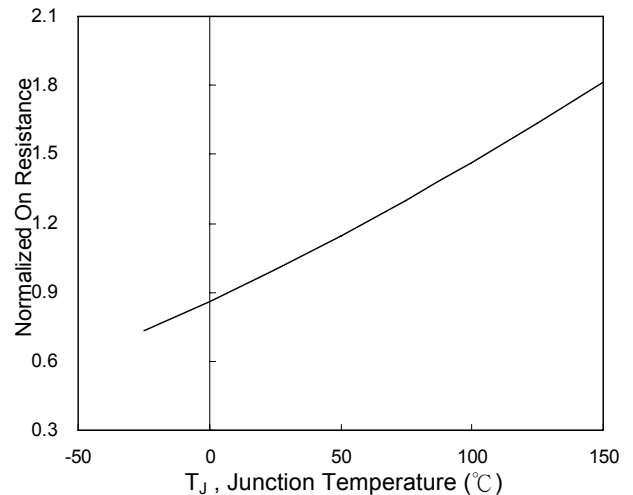


Fig.6 Normalized R_{DS(on)} vs. T_J



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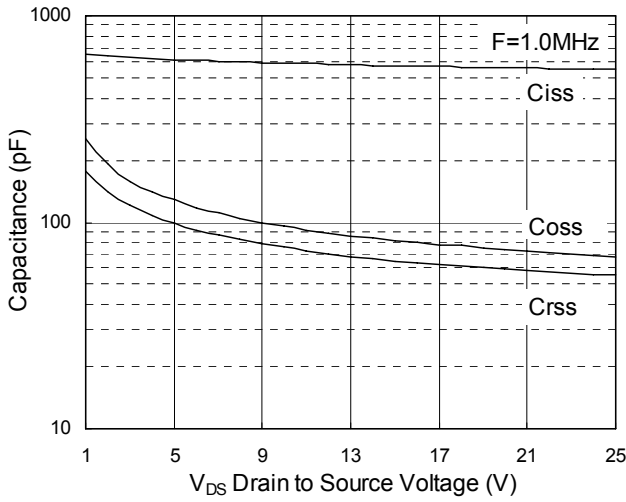


Fig.7 Capacitance

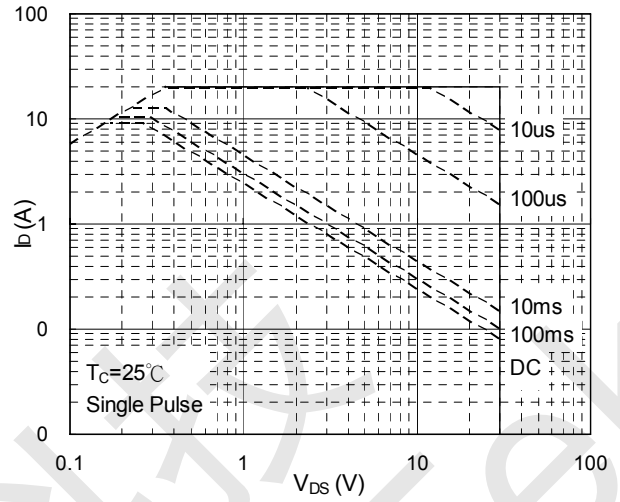


Fig.8 Safe Operating Area

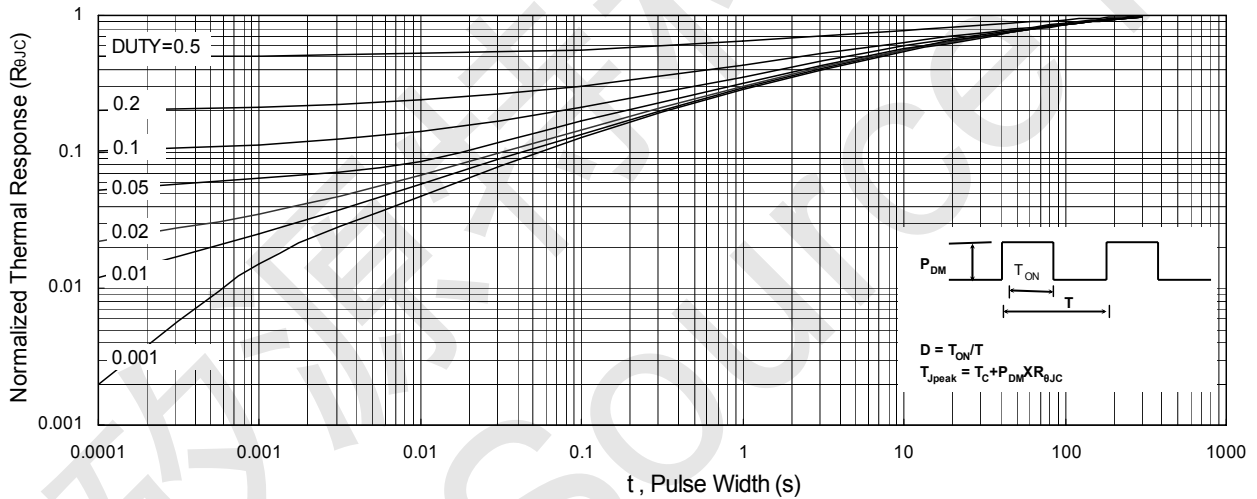


Fig.9 Normalized Maximum Transient Thermal Impedance

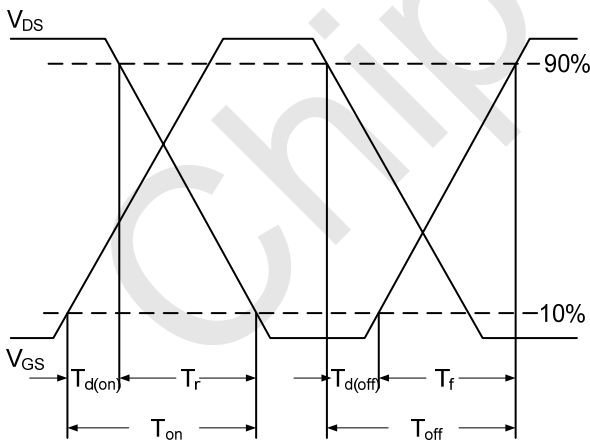


Fig.10 Switching Time Waveform

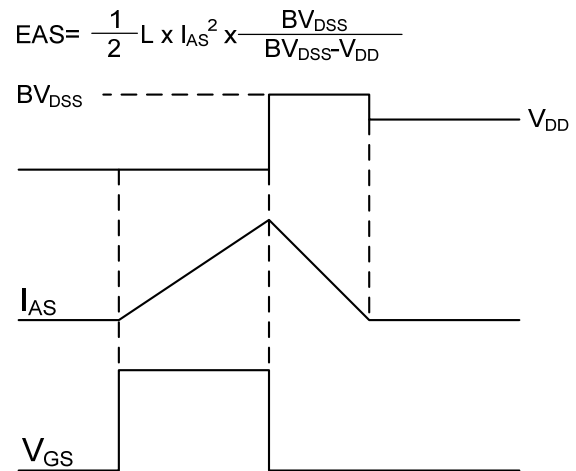


Fig.11 Unclamped Inductive Waveform



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CST4606A P-Channel Typical Characteristics

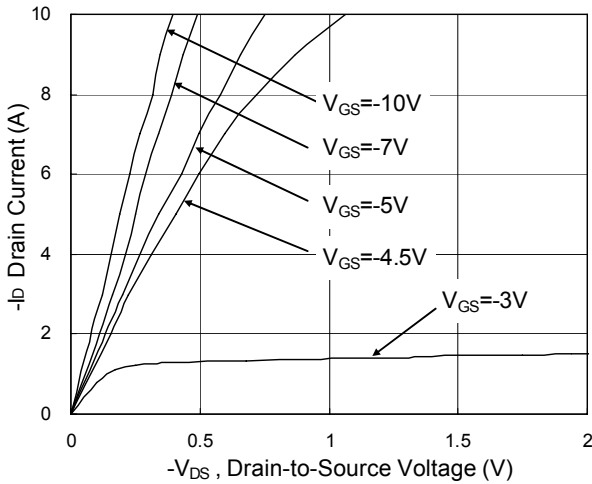


Fig.1 Typical Output Characteristics

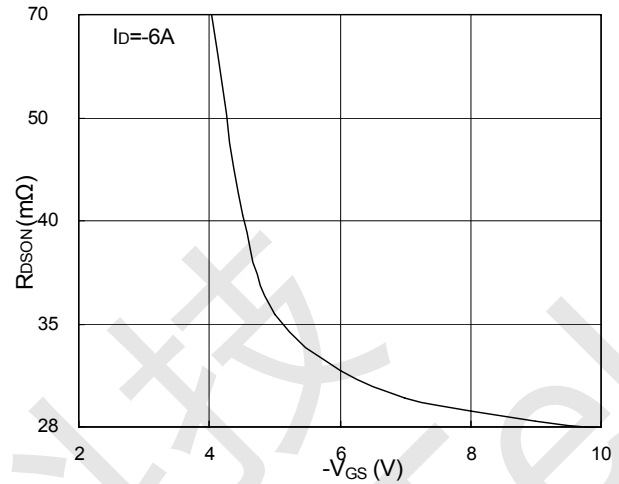


Fig.2 On-Resistance vs. Gate-Source

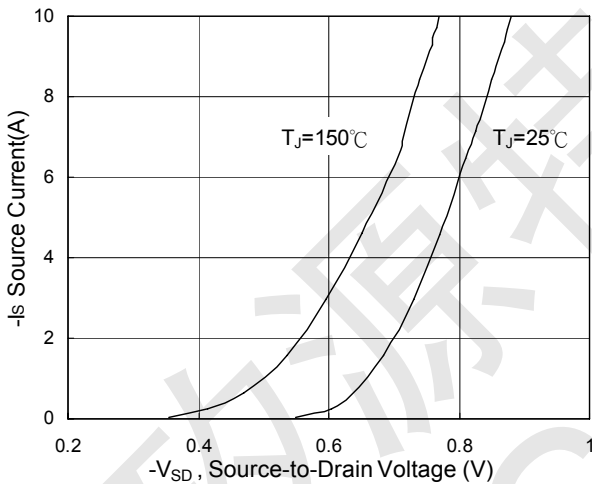


Fig.3 Forward Characteristics of Reverse

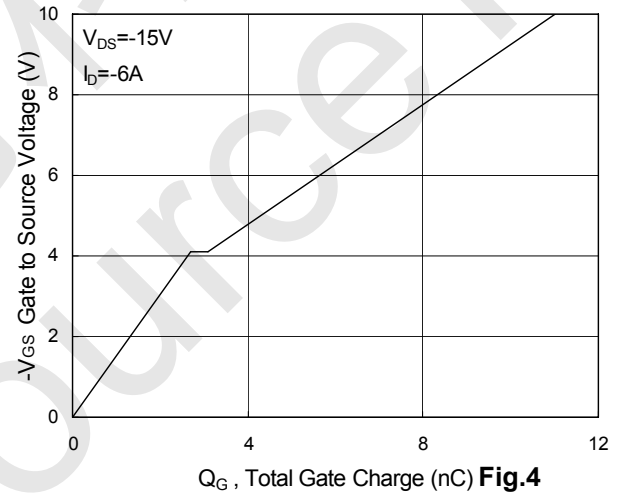


Fig.4

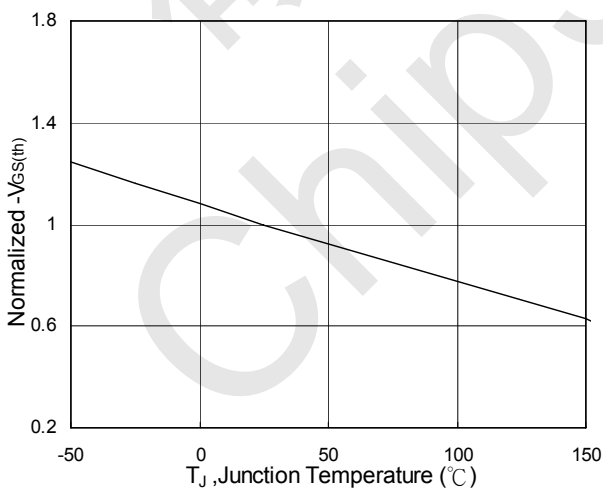


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

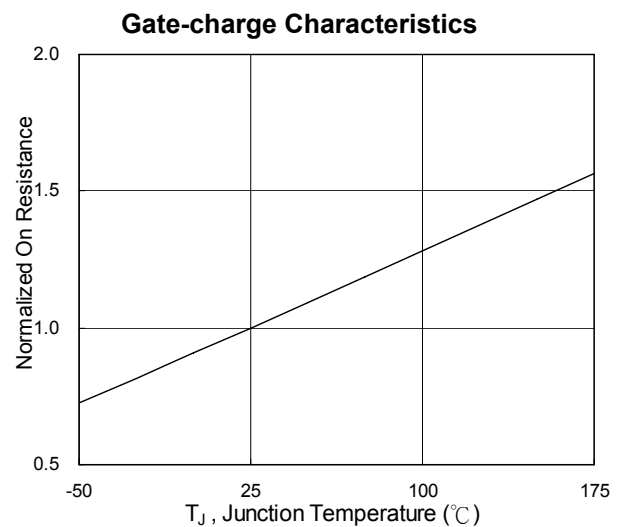
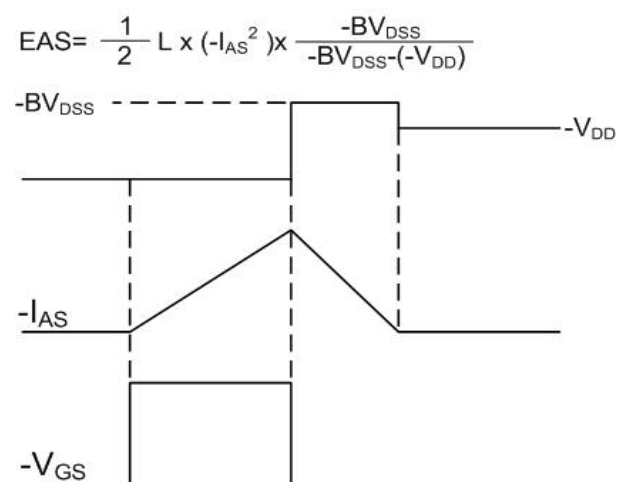
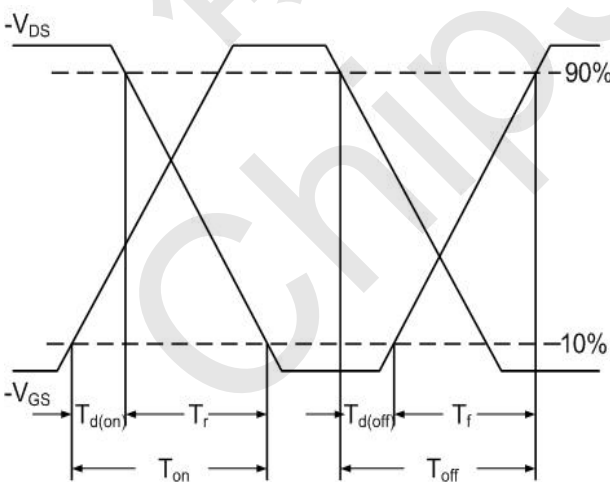
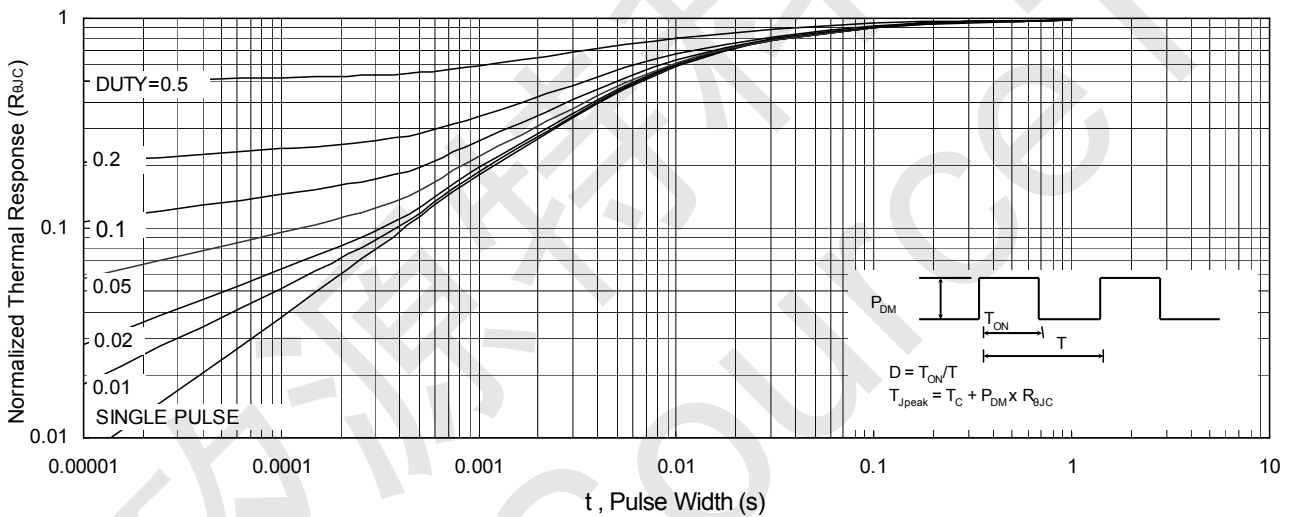
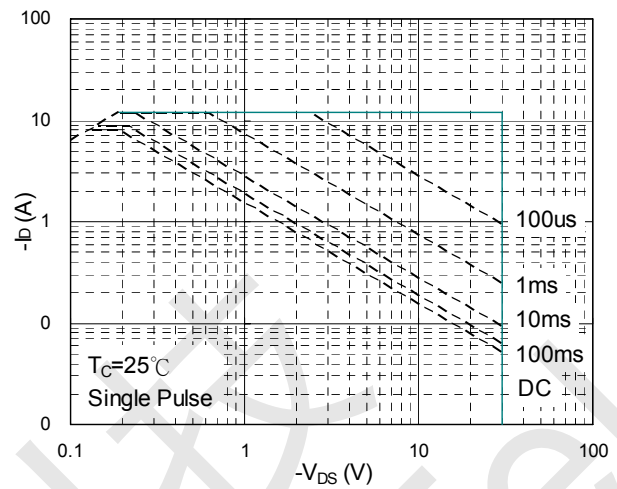
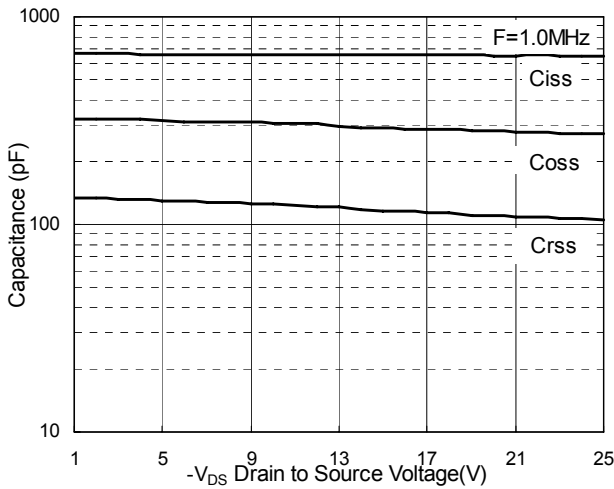


Fig.6 Normalized $R_{DS(on)}$ vs. T_J



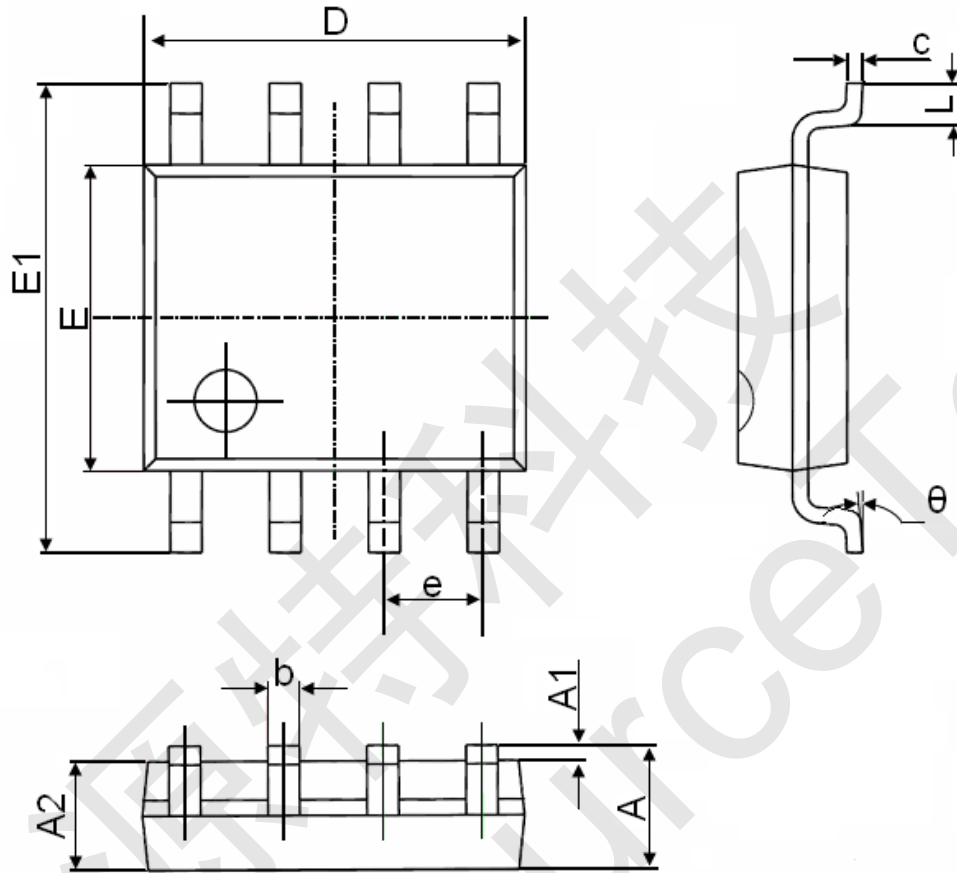
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$$EAS = \frac{1}{2} L \times (-I_{AS}^2) \times \frac{-BV_{DSS}}{-BV_{DSS} - (-V_{DD})}$$



CST4606A Package Mechanical Data- SOP-8



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.270(BSC) | | 0.050(BSC) | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| theta | 0° | 8° | 0° | 8° |